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## P-Channel 40 V (D-S) MOSFET

| PRODUCT SUMMARY |  |  |
| :---: | :---: | :---: |
| $\mathbf{V}_{\mathbf{D S}}(\mathbf{V})$ | $\mathbf{R}_{\mathbf{D S}(\mathrm{on})}(\Omega)$ | $\mathbf{I}_{\mathbf{D}}(\mathbf{A})^{\mathbf{a}}$ |
| -40 | 0.010 at $\mathrm{V}_{\mathrm{GS}}=-10 \mathrm{~V}$ | $\pm 55$ |
|  | 0.014 at $\mathrm{V}_{\mathrm{GS}}=-4.5 \mathrm{~V}$ | $\pm 54$ |

## FEATURES

- Compliant to RoHS Directive 2002/95/EC


RoHS*
COMPLIANT

TO-251



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ( $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$, unless otherwise noted)

| Parameter |  | Symbol | Limit | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Gate-Source Voltage |  | $\mathrm{V}_{\mathrm{GS}}$ | $\pm 40$ | V |
| Continuous Drain Current ( $\mathrm{T}_{J}=175^{\circ} \mathrm{C}$ ) | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | $\mathrm{I}_{\mathrm{D}}$ | $-55^{\text {a }}$ | A |
|  | $\mathrm{T}_{\mathrm{C}}=125^{\circ} \mathrm{C}$ |  | -52 |  |
| Pulsed Drain Current |  | $\mathrm{I}_{\mathrm{DM}}$ | - 220 |  |
| Avalanche Current |  | $\mathrm{I}_{\text {AR }}$ | -60 |  |
| Repetitive Avalanche Energy ${ }^{\text {b }}$ | $\mathrm{L}=0.1 \mathrm{mH}$ | $\mathrm{E}_{\text {AR }}$ | 180 | mJ |
| Power Dissipation | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | $P_{\text {D }}$ | 45 | W |
|  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | 3.75 |  |
| Operating Junction and Storage Temperature Range |  | $\mathrm{T}_{\mathrm{J}}, \mathrm{T}_{\text {stg }}$ | - 55 to 175 | ${ }^{\circ} \mathrm{C}$ |

## THERMAL RESISTANCE RATINGS

| Parameter |  | Symbol | Limit | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Junction-to-Ambient | PCB Mount (TO-263) ${ }^{\text {c }}$ | $\mathrm{R}_{\text {thJA }}$ | 40 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
|  | Free Air (TO-220AB) |  | 62.5 |  |
| Junction-to-Case |  | $\mathrm{R}_{\text {thJC }}$ | 0.8 |  |

Notes:
a. Package limited.
b. Duty cycle $\leq 1 \%$.
c. When mounted on $1^{\prime \prime}$ square PCB (FR-4 material).
d. See SOA curve for voltage derating

* Pb containing terminations are not RoHS compliant, exemptions may apply.

| SPECIFICATIONS ( $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$, unless otherwise noted) |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Parameter | Symbol | Test Conditions | Min. | Typ. | Max. | Unit |
| Static |  |  |  |  |  |  |
| Drain-Source Breakdown Voltage | $\mathrm{V}_{\mathrm{DS}}$ | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-250 \mu \mathrm{~A}$ | -40 |  |  | V |
| Gate Threshold Voltage | $\mathrm{V}_{\mathrm{GS} \text { (th) }}$ | $\mathrm{V}_{\mathrm{DS}}=\mathrm{V}_{\mathrm{GS}}, \mathrm{I}_{\mathrm{D}}=-250 \mu \mathrm{~A}$ | -1.0 |  | -2.5 |  |
| Gate-Body Leakage | $\mathrm{I}_{\text {GSS }}$ | $\mathrm{V}_{\mathrm{DS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}= \pm 20 \mathrm{~V}$ |  |  | $\pm 100$ | nA |
| Zero Gate Voltage Drain Current | $\mathrm{I}_{\text {DSS }}$ | $\mathrm{V}_{\mathrm{DS}}=-40 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}$ |  |  | -1 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\mathrm{DS}}=-40 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{J}}=125^{\circ} \mathrm{C}$ |  |  | - 50 |  |
|  |  | $\mathrm{V}_{\mathrm{DS}}=-40 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{J}}=175^{\circ} \mathrm{C}$ |  |  | -250 |  |
| On-State Drain Current ${ }^{\text {a }}$ | $\mathrm{I}_{\mathrm{D} \text { (on) }}$ | $\mathrm{V}_{\mathrm{DS}}=-5 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=-10 \mathrm{~V}$ | -120 |  |  | A |
| Drain-Source On-State Resistance ${ }^{\text {a }}$ | $\mathrm{R}_{\mathrm{DS} \text { (on) }}$ | $\mathrm{V}_{G S}=-10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-30 \mathrm{~A}$ |  | 0.010 |  | $\Omega$ |
|  |  | $\mathrm{V}_{G S}=-10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-30 \mathrm{~A}, \mathrm{~T}_{J}=125^{\circ} \mathrm{C}$ |  | 0.016 |  |  |
|  |  | $\mathrm{V}_{\mathrm{GS}}=-10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-30 \mathrm{~A}, \mathrm{~T}_{\mathrm{J}}=175^{\circ} \mathrm{C}$ |  | 0.023 |  |  |
|  |  | $\mathrm{V}_{\mathrm{GS}}=-4.5 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-20 \mathrm{~A}$ |  | 0.014 |  |  |
| Forward Transconductance ${ }^{\text {a }}$ | $\mathrm{g}_{\text {fs }}$ | $\mathrm{V}_{\mathrm{DS}}=-15 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-75 \mathrm{~A}$ | 20 |  |  | S |
| Dynamic ${ }^{\text {b }}$ |  |  |  |  |  |  |
| Input Capacitance | $\mathrm{C}_{\text {iss }}$ | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=-25 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ |  | 3000 |  | pF |
| Output Capacitance | $\mathrm{C}_{\text {oss }}$ |  |  | 620 |  |  |
| Reversen Transfer Capacitance | $\mathrm{C}_{\text {rss }}$ |  |  | 315 |  |  |
| Total Gate Charge ${ }^{\text {c }}$ | $Q_{g}$ | $\mathrm{V}_{\mathrm{DS}}=-15 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=-10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-75 \mathrm{~A}$ |  | 160 |  | $n \mathrm{C}$ |
| Gate-Source Charge ${ }^{\text {c }}$ | $\mathrm{Q}_{\mathrm{gs}}$ |  |  | 32 |  |  |
| Gate-Drain Charge ${ }^{\text {c }}$ | $\mathrm{Q}_{\mathrm{gd}}$ |  |  | 30 |  |  |
| Turn-On Delay Time ${ }^{\text {c }}$ | $\mathrm{t}_{\mathrm{d}(\mathrm{on})}$ | $\begin{gathered} V_{D D}=-15 \mathrm{~V}, R_{L}=0.2 \Omega \\ \mathrm{I}_{\mathrm{D}} \cong-75 \mathrm{~A}, \mathrm{~V}_{\mathrm{GEN}}=-10 \mathrm{~V}, \mathrm{R}_{\mathrm{g}}=2.5 \Omega \end{gathered}$ |  | 25 | 40 | ns |
| Rise Time ${ }^{\text {c }}$ | $\mathrm{t}_{\mathrm{r}}$ |  |  | 225 | 360 |  |
| Turn-Off Delay Time ${ }^{\text {c }}$ | $\mathrm{t}_{\mathrm{d}(\mathrm{off})}$ |  |  | 150 | 240 |  |
| Fall Time ${ }^{\text {c }}$ | $t_{f}$ |  |  | 210 | 340 |  |
| Source-Drain Diode Ratings and Characteristics ${ }^{\text {b }}$ ( $\left.\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}\right)$ |  |  |  |  |  |  |
| Continuous Current | Is |  |  | -220 |  | A |
| Pulsed Current | $\mathrm{I}_{\text {SM }}$ |  |  |  | -240 |  |
| Forward Voltage ${ }^{\text {a }}$ | $\mathrm{V}_{\text {SD }}$ | $\mathrm{I}_{\mathrm{F}}=-75 \mathrm{~A}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}$ |  | -1.2 | -1.5 | V |
| Reverse Recovery Time | $\mathrm{t}_{\mathrm{rr}}$ | $\mathrm{I}_{\mathrm{F}}=-75 \mathrm{~A}, \mathrm{~d} / \mathrm{dt}=100 \mathrm{~A} / \mu \mathrm{s}$ |  | 55 | 100 | ns |
| Peak Reverse Recovery Current | $\mathrm{I}_{\mathrm{RM}(\mathrm{REC})}$ |  |  | 2.5 | 5 | A |
| Reverse Recovery Charge | $\mathrm{Q}_{\mathrm{rr}}$ |  |  | 0.07 | 0.25 | $\mu \mathrm{C}$ |

## Notes:

a. Pulse test; pulse width $\leq 300 \mu \mathrm{~s}$, duty cycle $\leq 2 \%$.
b. Guaranteed by design, not subject to production testing.
c. Independent of operating temperature.

[^0]TYPICAL CHARACTERISTICS ( $25^{\circ} \mathrm{C}$, unless otherwise noted)


TYPICAL CHARACTERISTICS $\left(25^{\circ} \mathrm{C}\right.$, unless otherwise noted)


On-Resistance vs. Junction Temperature


Avalanche Current vs. Time



Drain Source Breakdown vs. Junction Temperature

## THERMAL RATINGS



## TO-251AA (DPAK)



|  | MILLIMETERS |  | INCHES |  |
| :---: | :---: | :---: | :---: | :---: |
| Dim | Min | Max | Min | Max |
| A | 2.21 | 2.38 | 0.087 | 0.094 |
| A1 | 0.89 | 1.14 | 0.035 | 0.045 |
| b | 0.71 | 0.89 | 0.028 | 0.035 |
| b1 | 0.76 | 1.14 | 0.030 | 0.045 |
| b2 | 5.23 | 5.43 | 0.206 | 0.214 |
| c | 0.46 | 0.58 | 0.018 | 0.023 |
| c1 | 0.46 | 0.58 | 0.018 | 0.023 |
| D | 5.97 | 6.22 | 0.235 | 0.245 |
| E | 6.48 | 6.73 | 0.255 | 0.265 |
| e | 2.28 BSC |  | 0.090 |  |
| L | 8.89 | 9.53 | 0.350 | 0.375 |
| L1 | 1.91 | 2.28 | 0.075 | 0.090 |
| L2 | 0.89 | 1.27 | 0.035 | 0.050 |
| L3 | 1.15 | 1.52 | 0.045 | 0.060 |
| ECN: $:-03946-$ Rev. E, 09-Jul-01 |  |  |  |  |
| DWG: 5346 |  |  |  |  |

Note: Dimension L3 is for reference only.

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